EXHIBITOR PROSPECTUS

Your Customers and Competition will be there—Make sure you are too!

YOU ARE INVITED TO EXHIBIT AT THE
2015 IEEE Compound Semiconductor IC Symposium (CSICS)

www.csics.org
Dear Prospective Exhibitor,

The IEEE Compound Semiconductor IC Symposium (CSICS) is a highly regarded annual technical conference and exhibition at which distinguished experts in the field of semiconductor technology and circuit design gather to present and discuss their latest state-of-the-art developments and innovations. After 37 years of refinement, CSICS has become the premier symposium at which to present innovations demonstrating extreme results in the areas of circuit speed, RF frequency of operation, RF output power, efficiency, low noise and power dissipation. We also feature the very latest advances in device, modeling and manufacturing technology.

This year, the event will be held at the Sheraton New Orleans Hotel in New Orleans, Louisiana, USA on October 11-14, 2015. The technical program consists of dual-track paper sessions supplemented by topical panel sessions and short courses on current topics with plenty of refreshments and social events. As a complement to the technical program and a popular highlight of CSICS, we also hold a two-day technology exhibition. Based on its continually enthusiastic reception by all participants, this is an ideal venue for vendors to showcase their latest products, tools, and services.

As an exhibitor at CSICS, I can assure you of a highly receptive and informed community of technical experts who appreciate the opportunity to interact face-to-face with vendors on both a technical and a business level. Given the highly advanced nature of their work, our attendees are demanding in terms of their product requirements, are early adopters, and are very influential in the CS community and beyond.

The CSICS Exhibition features vendors offering various products and services including:

- Computer aided design tools
- Simulation and modeling software
- Semiconductor components
- Packaging
- Specialty semiconductor materials (epitaxy, substrates, high purity gases and related compounds)
- Manufacturing equipment including photolithography, etch, thin films, ion implantation
- Wafer surface analysis and metrology equipment and services
- High frequency test and characterization
- Technical publications and industry intelligence
- Foundry services for GaAs and related compounds as well as advanced silicon technologies.

The conference is located just 15 miles from Louis Armstrong International Airport in the historic French quarter of downtown New Orleans about 3 city blocks from Bourbon Street.

Information about CSICS can be found at www.csics.org.

We would be delighted to have your company participate in CSICS 2015 and if you have any further questions, please do not hesitate to get in touch with Lisa Boyd for registration and logistical information, or Mr. Nguyen and myself for technical matters.

We look forward to welcoming you to the CSICS Exhibition in 2015.

Sincerely,

Charles F. Campbell, Ph.D.  
2015 CSICS General Chair  
ccampbell@tqs.com

Thế Linh Nguyen  
2015 CSICS Exhibition Chair  
thelinh.nguyen@finisar.com
CONFERENCE HIGHLIGHTS

CONFERENCE SCOPE

From its beginning in 1978 as the GaAs IC symposium, CSICS has evolved to become the preeminent international forum for developments in compound semiconductor integrated circuits, embracing GaAs, InP, GaN, SiGe, and more recently, CMOS technology. Coverage includes all aspects of the technology, from materials issues and device fabrication, through IC design and testing, high volume manufacturing, and system applications. CSICS provides the ideal forum to present the latest results in high-speed digital, analog, microwave/millimeter wave, mixed mode, and optoelectronic integrated circuits. First-time papers concerned with the utilization and application of InP, GaAs, SiGe, GaN and other compound semiconductors in military and commercial products are invited. Specific technical areas of interest include:

- Innovative RFIC and mm-wave IC Device & Circuit Concepts
- Millimeter-wave/High-Speed IC Circuit Design & Fabrication
- Manufacturing Technology & Cost Issues
- CAD/CAM/CAT Tools & Techniques
- IC Testing & Methodology
- Packaging Technology
- Reliability
- Advanced Device Applications
- System Applications (e.g., wireless, vehicular, RADAR, military)
- Optoelectronic and OEIC applications

High quality technical papers will be selected from worldwide submissions for oral presentation and publication in the Symposium Digest. Invited papers and panel sessions on topics of current importance to the Compound Semiconductor IC community will complete the program.

OFFICIAL CONFERENCE DATES

Sunday, October 11 - Wednesday, October 14

LOCATION

Sheraton New Orleans Hotel
500 Canal Street
New Orleans, LA 70130
Tel: 504-595-5544

KEY DEADLINES

Paper Submission
17 April 2015

Booth Rental Early Registration
before 16 June 2015

Booth Rental Regular Registration
after 16 June 2015

Exhibitor Payment Due
15 September 2015

Hotel Reservation Cut-off
17 September 2015 at 5:00 PM PST

INTERESTED IN EXHIBITING?

Contact:

Candi Wooldridge
303-530-4562
candi@mpassociates.com

Susie Horn, CEM
303-530-4562
susie@mpassociates.com
CONNECT & NETWORK WITH...

- Accel-RF Corporation
- AFRL/RYDI
- AIET
- Ammono S.A.
- Analog Devices Inc.
- Aurrion
- AWR Corporation
- BAE Systems
- Bell Laboratories
- Birch Nanotechnology Center
- Boeing
- Booz Allen Hamilton
- Broadcom Corporation
- Canadian Space Agency
- Cardiff University
- CEA-Leti
- Chalmers University of Technology
- Ciena Corporation
- Cisco Systems, Inc
- Cree
- DARPA
- DoD
- Ericsson AB
- Ferrotec USA Corp.
- Finisar Corp
- Fraunhofer Institute for Applied Solid State Physics IAF
- Freescale Semiconductor
- FUJITSU LABORATORIES LTD.
- General Dynamics
- Homeland Security
- Hong Kong University of Science and Technology
- HRL Laboratories, LLC
- IHP GmbH
- III-V Lab
- Integrand Software
- Intel Corp
- Keysight Technologies
- Kyocera America, Inc.
- Labone Complex
- Lockheed Martin
- Luxtera
- M/A -COM
- Macquarie University
- Maury Microwave
- MaXentric Technologies
- MaxLinear
- Mesuro Ltd
- Mission Microwave
- Mitsubishi Electric Corporation
- Mustang Technology Group
- Nanyang Technological University
- Navitas Semiconductors
- NCSU
- NEC Corporation
- NGC
- Nonlinear Technologies, Inc.
- North Carolina State University
- Northrop Grumman
- NTT
- Nuhertz Technologies, LLC
- Nuvotronics
- NXP Semiconductors
- OMMIC
- Oregon State University
- Penn State University
- Peraso Technologies
- Presidio Components, Inc.
- Purdue University
- Qualcom
- Quantum Information and Quantum Optics Group, Stockholm University, Sweden
- Quik-Pak
- QuinStar Technology
- Raytheon
- RFMD
- RLC Solutions
- Rockwell Collins Inc
- Rohde & Schwarz
- Sandia National Laboratories
- Silvaco
- Sindh High Court
- Skyworks
- Solution Center
- Sonnet Software
- SSC-PAC
- SSL
- Stanford University
- STMicroelectronics
- StratEdge Corporation
- Strategy Analytics
- Sumitomo Electric Industries, Ltd.
- System Planning Corporation
- Technische Universität
- Teledyne Scientific Company
- Terahertz Research Centre, CAEP, Chengdu, China
- The Boeing Company
- The Ohio State University
- TNO
- TriQuint
- TU Dresden
- UC Santa Barbara
- UC San Diego
- United Monolithic Semiconductors GmbH
- Univ. of Notre Dame
- Univeristy of Bristol
- University Federico II
- University of Illinois at Urbana Champaign
- University of Notre Dame
- University of Toronto
- University of Twente
- University of Wuppertal
- Vacuum Engineering & Materials
- WIN semiconductors
EXHIBIT OPPORTUNITIES

YOUR BOOTH RENTAL INCLUDES

<table>
<thead>
<tr>
<th>PRIOR TO JUNE 16 2015</th>
<th>AFTER JUNE 16 2015</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>$1,700</strong></td>
<td><strong>$2,000</strong></td>
</tr>
</tbody>
</table>

- 8’x10’ draped booth space for duration of exhibition (Monday & Tuesday)
- Table, two chairs, 500 Watt/120 V Power Drop
- Complimentary WiFi in the Exhibition Area
- Inclusion in the onsite printed exhibitor listing
- Company logo, description, and link on the conference website
- Mention in September symposium publicity articles
- List of symposium attendees consenting to share contact details (approx. 65% of attendance)
- One exhibitor badge with full access to all technical sessions, short courses and social events ($1,425 value)
- One exhibitor badge with access to all social events on Monday & Tuesday (during the exhibition)
- Extra full access exhibitor badge is $295
- Extra exhibitor badge for Monday & Tuesday social events is $195

TENTATIVE EXHIBIT HALL HOURS

<table>
<thead>
<tr>
<th>Day</th>
<th>START</th>
<th>END</th>
</tr>
</thead>
<tbody>
<tr>
<td>Exhibit Setup</td>
<td>7:30am</td>
<td>10:30pm</td>
</tr>
<tr>
<td>Exhibitor move-in</td>
<td>11:00am</td>
<td>2:00pm</td>
</tr>
<tr>
<td>Exhibit Hours</td>
<td>3:00pm</td>
<td>7:30pm</td>
</tr>
<tr>
<td>Welcome Reception</td>
<td>6:00pm</td>
<td>7:30pm</td>
</tr>
<tr>
<td>Breakfast with Exhibitors</td>
<td>7:00am</td>
<td>8:00am</td>
</tr>
<tr>
<td>Lunch with Exhibitors</td>
<td>12:00pm</td>
<td>1:30pm</td>
</tr>
<tr>
<td>Exhibitor move-out</td>
<td>5:00pm</td>
<td>7:00pm</td>
</tr>
</tbody>
</table>

Schedule is subject to change

All Symposium Social Events During Exhibitor Hours are held in the Exhibit Hall.

BENEFACtor OPPORTUNITIES

For both Silver & Gold Benefactor, Company logo displayed:
- On symposium webpage www.csics.org with link
- At the registration desk
- In the technical program overview slides
- On all technical session title slides
- In the Advanced Program and in the technical digest of papers

CSICS Gold Benefactor

Cost: **$6500**

Gold Benefactor with Exhibit Booth: **Cost: $7000**

- Benefit: Sponsors the Exhibition Opening Reception and will include a sign with the sponsoring company’s logo
- Includes Gold sponsorship publicity on the Symposium Website and the Advance Program

CSICS Silver Benefactor

Cost: **$3000**

Silver Benefactor with exhibit Booth: **Cost: $4000**

- Benefit: Sponsors a coffee break and will include a banner with the sponsoring company’s logo
- Includes Silver sponsorship publicity on the Symposium Website and the Advance Program

Benefactor Opportunities Promotional opportunities are available on a first-come, first-serve basis. Reserve the opportunities that spotlights your company’s name and start preparing for your company’s exposure at the event. To receive additional information on these opportunities PLEASE CONTACT:

Candi Wooldridge  
303-530-4562  
candi@mpassociates.com

Susie Horn, CEM  
303-530-4562  
susie@mpassociates.com

PRIOR TO JUNE 16 2015

$1,700

AFTER JUNE 16 2015

$2,000

• 8’x10’ draped booth space for duration of exhibition (Monday & Tuesday)
• Table, two chairs, 500 Watt/120 V Power Drop
• Complimentary WiFi in the Exhibition Area
• Inclusion in the onsite printed exhibitor listing
• Company logo, description, and link on the conference website
• Mention in September symposium publicity articles
• List of symposium attendees consenting to share contact details (approx. 65% of attendance)
• One exhibitor badge with full access to all technical sessions, short courses and social events ($1,425 value)
• One exhibitor badge with access to all social events on Monday & Tuesday (during the exhibition)
• Extra full access exhibitor badge is $295
• Extra exhibitor badge for Monday & Tuesday social events is $195
EXHIBITOR TERMS & CONDITIONS

1. Exhibit Space Assignment. Exhibit space will be assigned by show management (“MP Associates, Inc.”, agent for the IEEE CSIC Symposium organization) in accordance with the desires of the exhibitor for specific spaces and locations of direct competitors. Exhibit space assignment will be confirmed after full payment is received by show management. After the assignment, exhibit space located may not be changed or sublet or shared without the approval of show management and the exhibitor.

2. Exhibit space rental fee. See application form for rental fees schedule. Included in the cost of each booth rental is an 8’ x 10’ area with draped back and side rail dividers and an I.D. sign consisting of company name and booth number. Furniture, custom carpeting or equipment rental will be provided by the official decorator at an additional cost.

3. Cancellation. Cancellation of exhibit space must be made in writing. In the event of the cancellation of this contract by the applicant prior to the date of this show, show management may assess a cancellation charge according to the following schedule:

   Cancellation after August 3, 2015: 100% Booth Rental
   Cancellation before August 3, 2015: 50% Booth Rental

Show management reserves the right to reassign such canceled spaces. If this application is not accepted by show management, the applicant will be promptly notified and the monies returned. If the sponsoring organization decides to cancel the exhibit for any reason, all monies collected from exhibitors shall be fully refunded and the exhibitors shall not seek any claim whatsoever against show management for expenses incurred prior to show’s cancellation.

4. Use of exhibit booth. Show management reserves the right to restrict exhibits which, because of noise, method of operation, materials or for any other reason become objectionable, and also to prohibit or remove any exhibit which, in the opinion of show management may detract from the general character of the exposition as a whole. This reservation includes persons, things, conduct, printed matter, or anything which show management determines is objectionable. In the event of such restriction or removal, show management shall not be liable for any refunds or any exhibit expenses. Booths cannot be shared by two or more companies, unless they have a project or product in common which is being displayed at the show.

5. Booth Personnel. Booth must be staffed at all times during the official show hours. Exhibitor badges must be worn at all times in the exhibits area.

6. Dismantling. No exhibitor will be allowed to dismantle any part of his/her exhibit until the official closing of the show.

7. Security. 24 hour security will be provided by show management to prevent the entry by unauthorized persons. However, this service does not guarantee the exhibitors against loss or damage from any cause whatsoever, nor does it imply an assumption of liability by show management.

8. Liability. The IEEE CSIC Symposium organization and/or its agents shall not be responsible for any loss, theft, damage to the property of the exhibitors, his/her employees or representatives. Further, show management will not be liable for damage or injury to persons or property during the term of this agreement, nor for any claims, governmental charges or fines or attorney’s fees arising out of or caused by exhibitor’s installation, removal, maintenance, occupancy or use of the exhibition premises or part thereof, or from any other cause whatsoever by reason of the exhibit space by the exhibitor or his/her assigns. The exhibitor shall indemnify and hold show management, convention center, hotel, agents, affiliates, directors, officers, employees, servants and employees harmless from all or any liability or such losses, damages or claims which may ensue from any cause, including as a result of strikes, riots, acts of God, terrorism, or any other cause beyond its control.

9. Shipping. All exhibitors must follow shipping instructions to show site as provided by show management. Show management nor the facilities will accept any responsibility for lost or delayed shipments which have been sent to a different address such as their hotel or directly to the show site.

If the exhibitors material fails to arrive, or due to other causes beyond his/her control is prevented from using his/her space, the exhibitor is nevertheless responsible for his/her space rental. Exhibitors are advised to carry special insurance to cover exhibit material against damage or loss, and public liability insurance against injury to the person and property of others.
Reserve space for our exhibit at the 2015 IEEE Compound Semiconductor Integrated Circuits Symposium Technology Exhibition, to be held at the Sheraton New Orleans Hotel, New Orleans, LA, October 12-13, 2015. We understand that this application becomes a contract when signed by us and accepted by Show Management. We agree to abide by the Terms and Conditions on the following page hereof.

(Please type or print)

COMPANY NAME ___________________________________________________ WEB ADDRESS _______________________

ADDRESS _______________________________________________________________________________________

CITY __________________ STATE _______ ZIP _________ COUNTRY__________

CONTACT NAME ______________________________ E-MAIL ________________

PHONE ___________________________ FAX ___________________________

Rental Fees

EARLY PRIOR TO JUNE 16 2015

$1,700

REGULAR AFTER JUNE 16 2015

$2,000

NUMBER OF 8’ X 10’ EXHIBIT SPACE(S) REQUESTED _______________ AMOUNT ENCLOSED: $ _________________

Check/MO made payable to IEEE CSICS 2015

c/o LuRrecija Lelong
IEEE Meetings, Conferences, and Events
445 Hoes Lane
Piscataway, NJ 08854

Credit Card - Contact MP Associates, Inc. for credit card authorization form

Wire Transfer - $20 wire transfer fee applies. Contact MP Associates, Inc. for bank information

Space Assignment: We realize it is not always possible to be assigned the specific space requested; however, the following will give an indication of our preference: (review Exhibit Hall/Booth Floor Plan for preference)

Space Choices:

1ST ____________________________________________

2ND __________________________________________

3RD __________________________________________

For multiple booths, please indicate all booth numbers desired in configuration.

FOR OFFICIAL USE ONLY

Application Received: __________________________

Amount Received: ___________________________

Amount Due: _______________________________

Booth #’s Assigned: _______________________

PLEASE SIGN HERE:

Firm Name: X

By: X Authorized Signature

By: ______________________________ Show Management - MP Associates, Inc.
# COMPLIMENTARY/ADDITIONAL REGISTRATION

**October 12-13, 2015**  
New Orleans, LA

<table>
<thead>
<tr>
<th>Name</th>
<th>Email Address</th>
<th>Phone</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Complimentary Exhibits Only Attendee**

<table>
<thead>
<tr>
<th>Name</th>
<th>Email Address</th>
<th>Phone</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Complimentary Full Week Attendee**

<table>
<thead>
<tr>
<th>Name</th>
<th>Email Address</th>
<th>Phone</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Additional Full Access ($295) or Partial Access ($195) Attendees**

<table>
<thead>
<tr>
<th>Full Access</th>
<th>Partial Access</th>
</tr>
</thead>
<tbody>
<tr>
<td>Name</td>
<td>Email Address</td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Check/MO made payable to **IEEE CSICS 2015**  
c/o Lutrecija Lelong  
IEEE Meetings, Conferences, and Events  
445 Hoes Lane  
Piscataway, NJ 08854

Credit Card - **Contact MP Associates, Inc. for credit card authorization form**  
Wire Transfer - **$20 wire transfer fee applies.**  
**Contact MP Associates, Inc. for bank information**

**MP ASSOCIATES, INC.**  
PHONE: **303-530-4562**  
FAX: **303-530-4334**  
E-MAIL: candi@mpassociates.com or susie@mpassociates.com